

Case 2128
RN/ca

LOW POWER INTEGRATING CIRCUIT FOR USE WITH A PHOTODETECTOR AND
OPTICAL SENSOR INCLUDING SUCH AN INTEGRATING CIRCUIT

FIELD OF THE INVENTION

The present invention generally relates to optical sensors and more particularly to an integrating circuit and method for converting an input photo-generated current into an output voltage signal.

BACKGROUND OF THE INVENTION

Optical sensors are used in a large number of applications such as scanning or 5 digitising systems, optical pointing devices and imaging devices. Optical sensors generally operate by detecting electromagnetic radiation and producing an electrical signal that corresponds to the intensity of the electromagnetic radiation impinging on the optical sensor. Multiple optical sensors are generally used and are often 10 geometrically positioned in arrays with individual optical sensor corresponding to a respective pixel of the array.

Each optical sensor typically comprises a photodetector or photodetecting device, such as a photodiode or phototransistor, for converting electromagnetic radiation into an electrical signal. One specific type of optical sensor further includes 15 an integrating circuit associated with the photodetecting device. In such type of optical sensor, the photodetector generates a photocurrent the value of which is a function of the electromagnetic energy striking the photodetector and this photocurrent is integrated over time, i.e. converted, by the integrating circuit to produce an output voltage.

One already knows optical sensors which include a passive integrating circuit. 20 In such a passive type optical sensor, the photodiode used as photodetector (as well as its associated junction capacitance and attached parasitic capacitance) is initially biased to a high reverse voltage. The photodiode generates a photocurrent which discharges the capacitance, thereby causing the voltage to decrease. The output voltage for this type of optical sensor is generally non-linear with respect to the 25 integrated charge since the diode capacitance is a function of the diode voltage. A further disadvantage of the above passive type optical sensor resides in the fact that the integrating capacitance (defined in this case by the photodiode capacitance and the parasitic capacitance) is determined primarily by the photodiode size. Accordingly,

sensitivity cannot be increased by increasing the photodiode size since the capacitance will increase approximately proportionally.

- One additionally knows active-type optical sensors comprising a photodetector (typically a photodiode) coupled to an active integrating circuit basically comprising an 5 operational amplifier having a non-inverting input coupled to a reference voltage, an inverting input coupled to the photodiode and an output, an integrating capacitor being connected across the operational amplifier output and inverting input.

- An improved optical sensor and integrating circuit are proposed in U.S. Patent No. 6,031,217. According to this patent, the optical sensor comprises a photodetector 10 (preferably a photodiode) having an output proportional to the intensity of the electromagnetic radiation striking the photodetector and an active integrating circuit coupled with the output of the photodetector for integrating the photodetector output over time to generate an output electrical signal. This integrating circuit basically comprises an operational amplifier having a non-inverting input coupled to a reference 15 voltage, an inverting input and an output, the photodetector being coupled to the amplifier inverting input and to the reference voltage. The integrating circuit further comprises an integrating voltage storage device, i.e. a capacitor, connected across the operational amplifier output and inverting input for storing an accumulated electrical signal from the photodetector. Switching circuitry is further provided for controlling the 20 timing of the active integrating circuit.

- According to the above patent, the integrating circuit is operated in such a way as to maintain a photodiode biased at a level close to zero, thereby reducing any associated dark currents. By resetting the output of the integrating circuit to near zero, prior to the start of each integrating cycle, the dark level output of the circuit is 25 sufficiently close to ground that dark level baseline restoration is not normally required. The result is a lower pixel-to-pixel dark level variation and also a reduction in dark current errors at elevated temperatures. In addition, for variable temperature situations, the dark level currents may be reduced and the sensitivity increased as compared to comparable techniques using reversed biased photodiodes.
- As mentioned above, the output of the integrating circuit is reset to near zero prior to the start of each integrating cycle. The voltage across the integrating capacitor is therefore null during reset, i.e. below the threshold voltage of a standard MOS transistor. Accordingly, one disadvantage of the solution disclosed in U.S. Patent 30 No. 6,031,217 resides in the fact that it is not possible to realize the integrating capacitor as a standard MOS transistor, i.e. a MOS transistor having source and drain terminals connected together. Poly or metal layers must therefore be used, which are very area-inefficient.

Maintaining a zero bias voltage across the photodiode indeed has the advantage of reducing any associated dark currents as described in the above patent. However, the photodiode "needs" a large reverse bias across it to be fast and efficient in its collection of photon-generated current. For applications requiring short response time and high collection efficiency, the solution proposed in U.S. Patent No. 6,031,217 is therefore not adequate.

Another disadvantage of the above solution resides in the fact that the optical sensor requires two separate control lines (designated OSZERO and RUN in U.S. Patent No. 6,031,217) for zeroing the operational amplifier and for controlling the timing of the integrating circuit. It is generally preferable to keep the number of external lines at a minimum so as to reduce the number of connections to each optical sensor which inevitably necessitate area on the chip.

Accordingly, it is an object of the present invention to provide an optical sensor comprising a photodetector and an integrating circuit which makes it possible to use a standard MOS component as integrating capacitor, thereby avoiding extra process steps, such as the formation of a second poly or metal layer and using die area in a more efficient manner.

A further object of the present invention is to provide a solution that allows to maintain a relatively large reverse bias across a photodiode so as to ensure a fast and efficient collection of photon-generated charges.

Still another object of the present invention is to minimize the number of external connections of the optical sensor in order to avoid wasting area in applications necessitating multiple optical sensors, such as in the case of optical sensing arrays.

Yet another object of the present invention is to provide an optical sensor that may be operated at low voltages and that exhibits low power dissipation.

Another object of the present invention is to provide a solution that meets several other requirements and constraints such as, amongst other things, large output signal swing, high integration gain, high amplifier gain in both modes

(integration/run and reset) for accurate reset and integration, amplifier stability, low output impedance to drive the followings signal processing stages, output signal level such that single-pass-transistor switches can be used in following signal blocks, minimal parasitic capacitance at photodiode input, and area efficient layout.

SUMMARY OF THE INVENTION

- According to a first aspect of the invention, there is provided an optical sensor for producing an electrical signal in response to electromagnetic radiation, comprising :
- a photodetector having an output supplying an electrical signal proportional to the intensity of the electromagnetic radiation striking the photodetector; and
- 5 an integrating circuit coupled with the output of the photodetector to accumulate the electrical signal from the photodetector, the integrating circuit comprising :
- an operational amplifier having a non-inverting input connected to a non-zero bias voltage, an inverting input coupled to the photodetector, and at least one output;
- 10 an integrating voltage storage device having a first terminal coupled to the operational amplifier output and a second terminal coupled to the operational amplifier inverting input; and
- switching circuitry for controlling timing of the integrating circuit and switching the integrating circuit between a reset phase and an integration phase,
- 15 wherein the switching circuitry includes means for balancing the operational amplifier and developing a voltage across the integrating voltage storage device during the reset phase, which voltage is substantially equal to the bias voltage, the first terminal of the integrating voltage storage device being pulled to a reference potential during the reset phase.
- 20 According to a second aspect of the invention, there is provided an integrating circuit for use with a photodetector having an output supplying an electrical signal proportional to the intensity of the electromagnetic radiation striking the photodetector, the integrating circuit comprising :
- an operational amplifier having a non-inverting input connected to a non-zero bias voltage, an inverting input capable of being coupled to said photodetector, and at least one output;
- 25 an integrating voltage storage device having a first terminal coupled to the operational amplifier output and a second terminal coupled to the operational amplifier inverting input;
- 30 an output stage comprising a gate terminal connected to the operational amplifier and an output terminal connected to the first terminal of the integrating voltage storage device; and
- switching circuitry for controlling timing of the integrating circuit and switching the integrating circuit between a reset phase and an integration phase,
- 35 wherein the switching circuitry includes means for balancing the operational amplifier and developing a voltage across the integrating voltage storage device during the reset phase, which voltage is substantially equal to the bias voltage, the first

terminal of the integrating voltage storage device being pulled to a reference potential during the reset phase.

- According to a particular embodiment of the invention, the integrating circuit includes an output stage comprising a gate terminal connected to the operational 5 amplifier output and an output terminal connected to the first terminal of the integrating voltage storage device, the switching circuitry including :

a first switching device for connecting the output stage gate terminal to the inverting input during the reset phase and for disconnecting the output stage gate terminal from the inverting input during the integration phase; and

- 10 a second switching device for pulling the output stage output terminal to the reference potential during the reset phase and for releasing the output stage output terminal from the reference potential during the integration phase.

The present invention provides a solution which allows photodetectors having large light capturing capability to be used (despite the consequently large photodiode 15 capacitance). In case the photodetector is a photodiode, the invention further allows a large bias voltage to be applied across the photodiode for it to be fast and efficient in its collection of photon-generated current, without this leading to limitations in the low voltage supply that may be used to power the circuit.

- In addition, for the photocurrent-to-voltage output gain to be large, the 20 integrating voltage storage device needs to be small. By putting the integrating voltage storage device around a feedback amplifier, the photocurrent is forced onto the desired integrating voltage storage device (rather than on the large parasitic photodiode capacitor). Indeed, the feedback amplifier forces the input voltage of the amplifier to remain constant, which prevents the photodiode capacitor from 25 accumulating any of the charge and forces the current to flow through the integrating voltage storage device.

Another advantage of the present invention resides in the fact that the circuit allows different voltages to be generated at the input and output during the reset phase, hence allows a voltage to be applied across the integrating voltage storage 30 device (which is substantially equal to the photodetector bias voltage) which is sufficient for allowing the integrating voltage storage device to be formed of a capacitor-connected standard MOS transistor, the voltage being above the threshold voltage of such transistor.

- Still another advantage of the invention resides in the fact that the integrating 35 circuit may be operated at a low voltage in an optimal manner. Indeed, since the integrating circuit output is pulled during reset to a reference potential such as ground, while maintaining a sufficient voltage across the integrating voltage storage device, the

integrating circuit output will ramp up from ground during integration (in case the photodetector is an n-well photodiode). The maximum circuit output voltage (with reference to ground) is thus defined by the allowable maximum output voltage ramp at the end of the integration. For a low-voltage supply, the maximum circuit output

5 voltage can therefore be maximized resulting in a more optimal design.

In addition, the integrating circuit output typically drives subsequent signal processing blocks, which often consist of multiplexors and other switches. In order to minimize area (signal connections and transistors) in all on-chip circuitry, these switches need to be single transistor switches of small area. In a low supply voltage

10 case, the gate drive of these switches must be able to get substantially above a threshold voltage above both the minimum (in this case ground) and the maximum signal swing (i.e. the maximum output voltage). Since the integrating circuit output ramps up from ground (still in the case of a n-well photodiode), this requirement can more easily be fulfilled with the circuit of the present invention.

15 Furthermore, it is usually difficult to fit a source-follower output stage into the feedback amplifier in order to lower the output impedance. Doing so generally requires an additional increase in the supply voltage, or a reduction in amplifier gain. If the output impedance is high, then compromises must be made in the following signal processing blocks, requiring additional circuitry, power or performance penalties. The 20 present invention advantageously allows such a source-follower output stage to be used.

Other aspects, features and advantages of the present invention will be apparent upon reading the following detailed description of non-limiting examples and embodiments made with reference to the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

25 - Figure 1 is a schematic block diagram of an optical sensor comprising a photodetector and an integrating circuit according to one embodiment of the present invention ;

- Figure 2 is a circuit diagram illustrating a first example of an integrating circuit according to the present invention ; and

30 - Figure 3 is a circuit diagram illustrating a second example of an integrating circuit according to the present invention.

DETAILED DESCRIPTION OF THE INVENTION

- Figure 1 is a generalized schematic bloc diagram of an optical sensor, indicated globally by reference numeral 1, including a photodetector 10 and an integrating circuit 20. The illustrated photodetector 10 here consists of a reverse-biased photodiode 11 (such as an n-well photodiode formed in a p-type semiconductor substrate). For the purposes of this description, the term "photodetector" includes any detector sensitive to radiant energy. Examples include in particular photodiodes, photo-gates and phototransistors. Reference numeral 12 denotes the photodiode capacitance C_{PD} . Photodetector 10 has an output 13 which is coupled to integrating circuit 20.
- Integrating circuit 20 includes an operational amplifier 30 having an inverting input 31 coupled to photodetector 10, a non-inverting input 32 coupled to a non-zero bias voltage $V_{PD-BIAS}$, which set the desired photodiode reverse bias voltage, and an output 33. By way of non limiting illustration, the photodetector bias voltage is nominally 1.5 Volts.
- An integrating voltage storage device 25 (of capacitance value C_{INT}) is connected in a negative amplifier feedback loop, i.e. has a first terminal (the integrating circuit output) coupled to the operational amplifier output 33 and a second terminal coupled to the operational amplifier inverting input 31.
- Preferably, an output stage 40 is interposed between the operational amplifier output 33 and the first terminal of the integrating voltage storage device 25. According to an embodiment of the invention, this output stage 40 is a source-follower output stage having a gate terminal 41 coupled to the operational amplifier output 33 and an output terminal 42 (source terminal of transistor 45) coupled to integrating voltage storage device 25. As already mentioned hereinabove, this source-follower output stage allows the output impedance to be lowered.
- As schematically illustrated in Figure 1, both the operational amplifier 30 and the output stage 40 are supplied by first and second supply potentials V_{SS} (ground) and V_{DD} . Purely for the purpose of illustration, the power supply $V_{DD} - V_{SS}$ can be as low as approximately 1.7 Volts, up to approximately 5.5 Volts. An adequate bias voltage V_{BIAS} is also applied to these two blocks.
- The integrating circuit 20 further comprises switching circuitry for controlling timing of the integrating circuit 20 and switching the integrating circuit between a reset phase and an integration phase. During the reset phase, the operational amplifier 30 is zeroed and balanced and the integrating voltage storage device 25 is reset (a voltage substantially equal to bias voltage $V_{PD-BIAS}$ being applied across device 25). At the same time, the integrating circuit output OUT is pulled to a reference potential (in this case ground potential V_{SS}). During the integration phase, the integrating circuit output

OUT (which is a voltage output) ramps up according to the intensity of the electromagnetic radiation striking photodetector 10. According to this embodiment, and by way of illustration only, the integrating circuit output will ramp up from V_{SS} to a maximum voltage approximately equal to 0.6 Volts.

- 5 It will be appreciated that the above explanation is based on the fact that an n-well photodiode is used as photodetector 10, the photodetector bias voltage being near the positive supply V_{DD}. In case photodetector 10 is a p-well photodiode formed in an n-type semiconductor substrate, the integrating circuit architecture will obviously be inverted and the integrating circuit output will ramp down from the "ground" potential (in such case V_{DD}).

- 10 According to the embodiment of Figure 1, the switching circuitry includes a first switching device 51 for connecting the operational amplifier output 33 to its inverting input 31 during the reset phase and for disconnecting the operational amplifier output 33 from its inverting input 31 during the integration phase. The switching circuitry 15 further includes a second switching device 52 for pulling the output stage output terminal 42 to the reference potential during the reset phase and for releasing this output stage output terminal 42 from the reference potential during the integration phase.

- As schematically illustrated in the embodiment of Figure 1, both the first and 20 second switching devices 51 and 52 are controlled by a single control signal RUN. During the reset phase (RUN at low state), switching device 51 is closed thereby connecting the operational amplifier output 33 and inverting input 31, and switching device 52 is open, the integrating circuit output OUT being pulled to the ground potential V_{SS} by means of a current source connected in series with the switching 25 device 52. During integration (RUN at high state), switching device 51 is open and switching device 52 is closed thereby allowing integrating circuit output OUT to ramp up from ground as a function of the photodetector illumination intensity.

- It will be appreciated at this stage that the voltage across integrating voltage storage device 25 is always greater than a threshold voltage of a standard CMOS 30 transistor. Accordingly, integrating voltage storage device 25 can advantageously be realized in the form of a MOS transistor operating in accumulation mode, the source and drain terminals (and bulk terminal) being connected together. This is advantageous in the sense that this allows to save substantial area and to manufacture storage device 25 in a standard CMOS process (no additional poly or 35 metal layer required). It will also be appreciated that conventional poly-poly, metal-poly, or metal-metal capacitors may nevertheless be used.

- Referring now to Figure 2, one will described in greater detail a possible and advantageous example of the integrating circuit 20 of Figure 1. In this example, operational amplifier 30 is a differential amplifier comprising a differential pair of transistors MN6 and MN7 and a half-folded cascode stage basically comprising
5 transistors MP4, MP7, MP9 and MN26.

- As illustrated in the circuit diagram of Figure 2, the gate terminals of transistors MN6 and MN7 respectively form the non-inverting input 32 and inverting input 31 of operational amplifier. The source terminals of transistors MN6 and MN7 are connected in common to a current source MN8 controlled by bias voltage V_{BIAS} . (for the purpose
10 of illustration only, this current source – as well as the other current sources – supplies a current of approximately 0.3 μA). The drain terminals of transistors MN6 and MN7 are respectively connected to the drain terminals of transistors MP4 and MP7 which form a current mirror. Transistors MP9 and MN26 are cascode transistors used to increase the node impedance and amplifier gain. Series connected transistors MP22
15 and MP11 are used to provide an adequate bias voltage for the gate terminal of cascode transistor MP9. Transistors MP7, MP9 and MN26 are connected in series with another current source MN4 controlled by bias voltage V_{BIAS} . Similarly, transistors MP22 and MP11 are also connected in series with a current source MN16 controlled by bias voltage V_{BIAS} .
20 As briefly mentioned hereinabove, output stage 40 advantageously includes a source-follower transistor 45 (transistor MN42), the gate and drain terminals of which are respectively connected to the operational amplifier output 33 (the connection node between cascode transistors MP9 and MN26) and to the positive supply potential V_{DD} .

- First switching device 51 is a single p-MOS transistor MP18 connected across
25 terminals 33, 41 and 31 and second switching device 52 is a single n-MOS transistor MN25 connected between the source terminal of source-follower transistor 45 and another current source MN24 controlled by bias voltage V_{BIAS} . The connection node between transistors MN25 and MN24 forms the integrating circuit output OUT. In addition, as clearly illustrated, switching transistors MP18 and MN25 are both
30 controlled by the RUN control signal, which is at a low state during reset and at a high state during integration.

- Integrating voltage storage device 25 is formed of capacitor-connected transistor MP30, the gate terminal of transistor MP30 being coupled to the operational amplifier inverting input 31 and the drain, source and bulk terminals of this transistor
35 MP30 being coupled to the integrating circuit output OUT. In this example, additional transistor MP31 is simply a spare for adjustment if necessary. It should be noted that

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MOS transistor MP30 is in "upside-down" accumulation mode, not normal inversion mode.

A compensation capacitor 60 (MOS transistor MN31) is further connected between the operational amplifier output 33 and ground V_{SS} in order to provide high

5 frequency compensation for operational amplifier 30.

Figure 2 also shows two bypass capacitors 71, 72 respectively formed of MOS transistors MP32 and MN29. Bypass capacitor 71 (transistor MP32) is connected across the supply lines V_{DD} and V_{SS}, whereas bypass capacitor 72 (transistor MN29) is connected across the positive input (non-inverting input 32) and ground V_{SS}. These

10 bypass capacitors 71, 72 are not really a functional part of the circuit and may be removed.

As an advantageous complement to the circuit which has just been described, two additional source-follower output stages may be added to provide minimum and maximum electrical output signals allowing determination of the optical sensor within

15 an array of multiple optical sensors with the least, respectively the greatest, intensity. This can be achieved by providing, for each optical sensor within the array, first and second source-follower output stages 91, 92 as illustrated and by connecting their outputs together to a single external current source (one for each max/min source-follower output stage). More particularly, first source-follower output stage 91

20 comprises a p-MOS transistor MP29, the source terminal of which forms the MinOut output which is connected to an external current source (not illustrated) common to all sensors of the array. The gate terminal of transistor MP29 is connected to the integrating circuit output OUT, while the drain terminal is connected to ground V_{SS}. Similarly, second source-follower output stage 92 comprises an n-MOS transistor

25 MN21, the source terminal of which forms the MaxOut output which is connected to another external current source (not illustrated) common to all sensors of the array. The gate terminal of transistor MN21 is connected to the operational amplifier output 33, while the drain terminal is connected to the positive supply potential V_{DD}.

Figure 3 is another possible example of the integrating circuit 20 of Figure 1. It
30 shows a somewhat simplified version of the circuit diagram of Figure 2. In particular, this example does not include bypass capacitors 71, 72 and spare transistor MP31, and bias transistors MP22 and MP11 is conceptually reduced to a single transistor MP22 (the two-transistor arrangement is used in Figure 2 because of layout considerations). The rest of the circuit is substantially similar to that of Figure 2 and will accordingly not be described again.

Some other modifications may be made to the circuit of Figure 3. For instance, an optional block 80 for self generating the photodetector bias voltage V_{PD-BIAS} may

be formed within the area of each optical sensor to reduce the number of external lines, eliminating $V_{PD-BIAS}$ and V_{BIAS} lines, since neither of these is critical. By making them wires instead of in-pixel circuitry has however the advantage of allowing to save more area.

- 5 In addition, an optional extra current source (transistor MN32) connected directly to the source terminal of source-follower transistor 45 improves the action of this source-follower (transistor MN42) during the transition from reset to run, but requires some area.

- Having described the invention with regard to certain specific embodiments, it
- 10 is to be understood that these embodiments are not meant as limitations of the invention. Indeed, various modifications and/or adaptations may become apparent to those skilled in the art without departing from the scope of the annexed claims. For instance, the proposed embodiments are not necessarily limited to optical sensors using n-well photodiodes. As already mentioned, p-well photodiodes may equally be
- 15 used (this requiring a complementary circuit architecture). By way of extension, photodetectors which are functionally equivalent to photodiodes may also be used.